

● Features:

1. Emitted Color: Red, Green, Blue,
2. Lens Appearance: colorless diffused
3. 3.0x1.0x1.5mm standard package.
4. Suitable for all SMT assembly methods.
5. Compatible with infrared and vapor phase reflow solder process.
6. Compatible with automatic placement equipment.
7. This product doesn't contain restriction Substance, comply ROHS standard.
8. 256 level Color set.
9. High contrast.
10. Built-in support for continuous oscillation PWM output can be maintained static screen.
11. Its function will be automatically reset when power on and power off.
12. Single lane data transfer.
13. Transmission distance is beyond 10M.
14. Frequency of data signal : 800KHz
15. Power Consumption: 0.1W

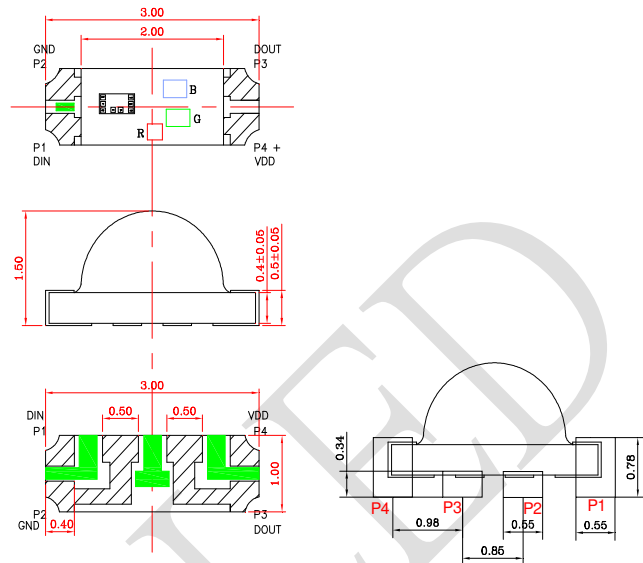
● Applications:

1. Large LED Display.
2. Soft Light Bar.
3. Full Color Display.

● Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Range	Unit
Supply voltage	VDD	4.5~5.5	V
Input Voltage	Vi	-0.4~VDD+0.4	V
Operating Temperature	Topt	-40°C ~85°C	-
Storage Temperature	Tstg	-40°C ~85°C	-
Soldering Temperature	Tsol	See Page 7	-

● Package Dimensions:



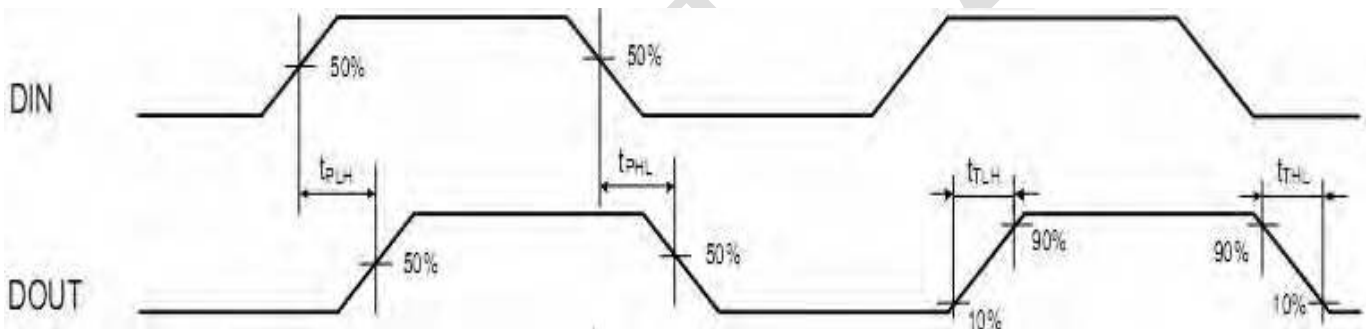
NOTES:

1. All dimensions are in millimeters.
2. Tolerance is ± 0.10 mm unless otherwise specified.
3. Specifications are subject to change without notice.



● Electrical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage	VDD	-	4.5	5.0	5.5	V
Input Voltage Level	VIH	DIN High Level	0.7*VDD	-	-	V
	VIL	DIN Low Level	-	-	0.3*VDD	V
Static current	IDD	VDD = 4.5V , Iout "OFF"	-	0.5	-	mA
R/G/B Constant Current	Iout	-	-	6	-	mA
Frequency of data signal	FDIN	-	-	800	-	KHz
Signal Transfer Delay Time	tPLH	DIN to DOUT	-	80	-	ns
Dout Conversion time	tPHL	-	-	80	-	ns
	tTLH	-	-	10	-	ns
	tTHL	-	-	12	-	ns

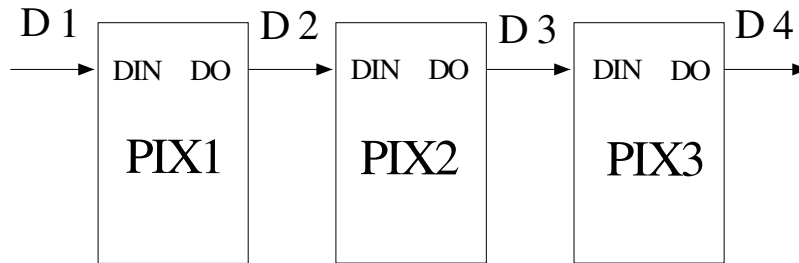


● Optical characteristics(Ta=25°C)

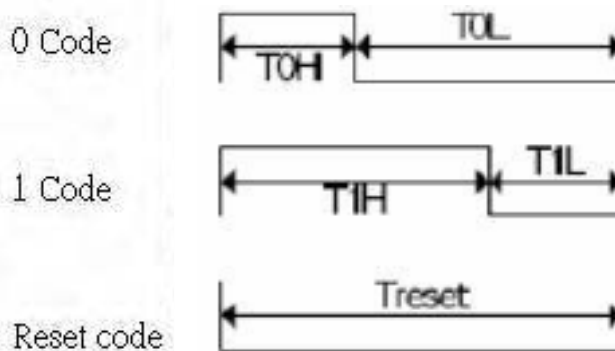
Parameter	Symbol	Condition	Min	Typ	Max.	Unit
Luminous Intensity	IV(R)	Iout=6mA	42	94	140	mcd
	IV(G)	Iout=6mA	63	140	210	mcd
	IV(B)	Iout=6mA	28	63	94	mcd
Dominant Wavelength	WLD(R)	Iout=6mA	620	630	640	nm
	WLD(G)	Iout=6mA	520	525	535	nm
	WLD(B)	Iout=6mA	460	465	475	nm
View Angle	2θ 1/2	Iout=6mA	-	120	-	deg

● Sequence Chart

Cascade method

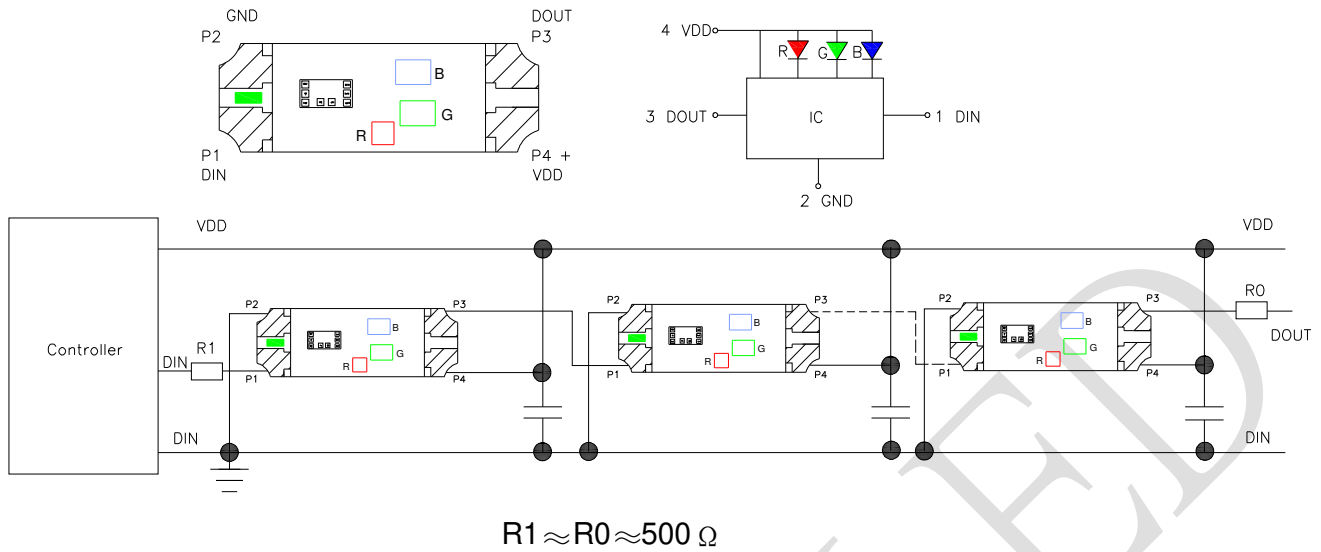


Input Code

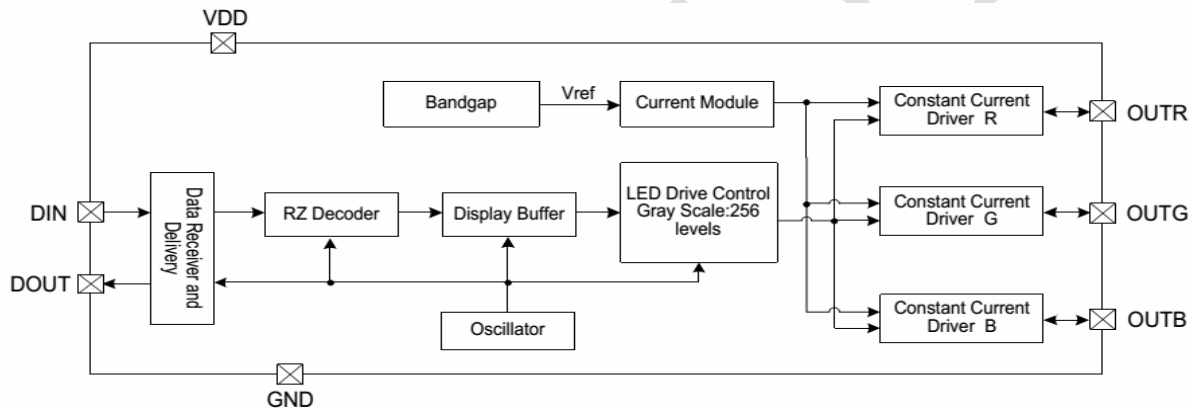


symbol	parameter	Min	Typ	Max	unit
T0H	0 Code, high level time	0.2	0.3	0.4	us
T1H	1 Code, high level time	0.55	0.6	1.0	us
T0L	0 Code, low level time	0.9	1.0	35	us
T1L	1 Code, low level time	0.6	0.7	35	us
Trst	Reset Code, low level time	100	150		us

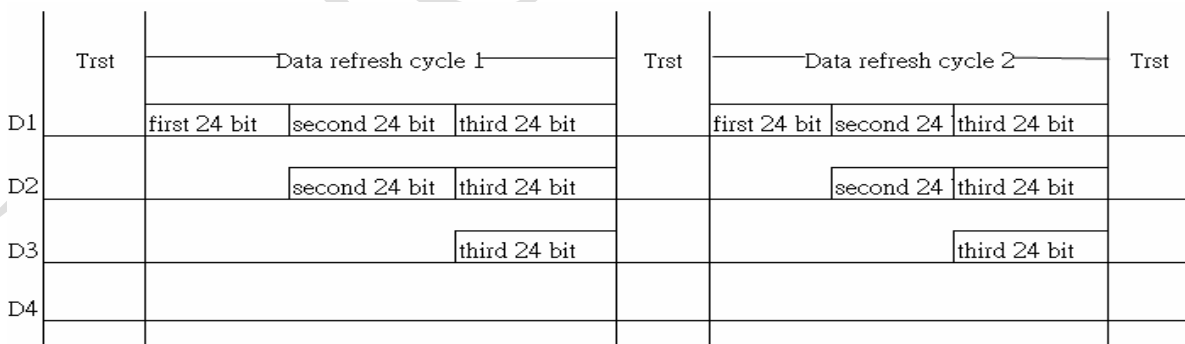
● Circuit diagram



● IC's function diagram



● Data transmission mode

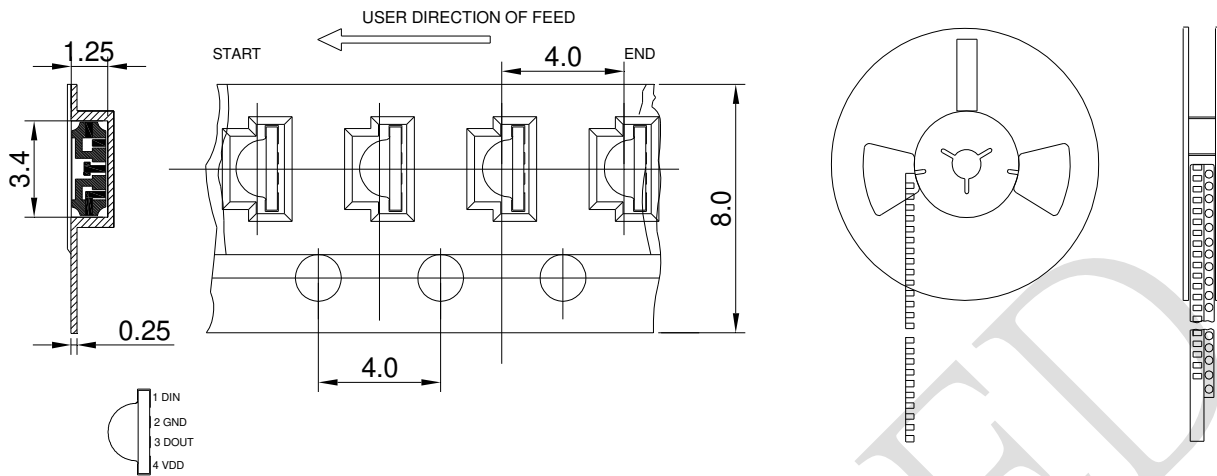


Note: D1 is the data sent by the MCU terminal, and D2, D3 and D4 are the data automatically reshaped and forwarded by the cascade circuit

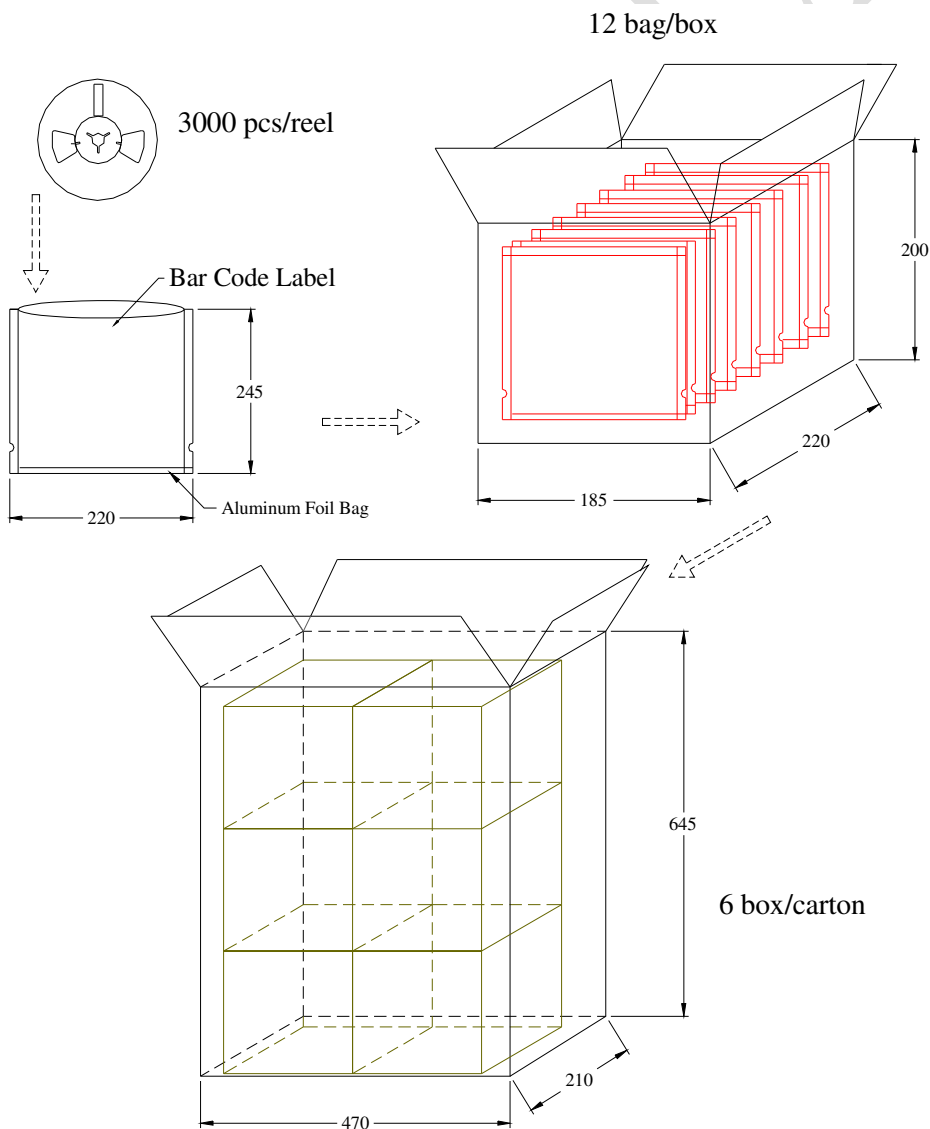
R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4
G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0

Note: Follow the order of RGB to send data and the high bit sent at first.

● Tapping and packaging specifications(Units: mm)



● Package Method: (unit : mm)





● Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	VDD=5V , Iout =6mA Ta=Under room temperature Test time=1,000hrs	0/20
	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+65°C±5°C RH=90%-95% Test time=240hrs	0/20
	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-35°C±5°C Test time=1,000hrs	0/20
Environmental Test	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	-35°C ~ +25°C ~ +85°C ~ +25°C 60min 20min 60min 20min Test Time=5cycle	0/20
	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-35°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle	0/20
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating : 140°C-160°C, within 2 minutes. Operation heating : 260°C (Max.), within 10seconds. (Max.)	0/20

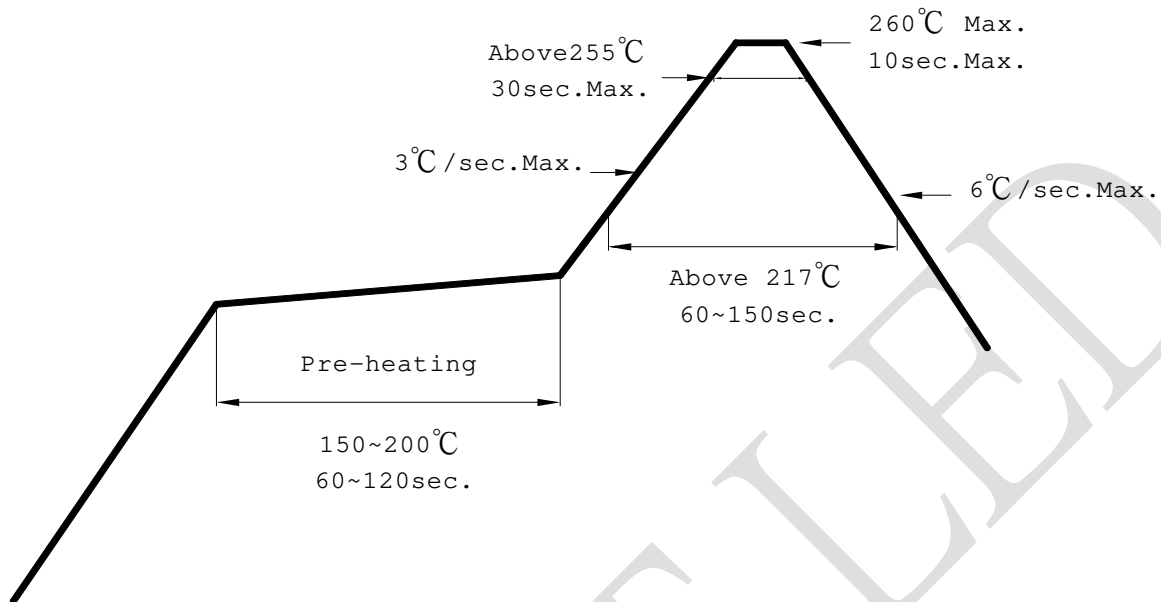
● Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Luminous intensity	Iv (mcd)	VDD=5V Iout =6mA	Below S ¹ X0.5

Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. After each test, remove test pieces, wait for 2 hours and test pieces have returned to ambient temperature, then take next measurement.

● IR-Reflow Soldering



1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering .
2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
3. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

● IRON Soldering

350°C Within 3 sec.,One time only.



● Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the BRIGHT LEDs within the rated figures. Also, caution should be taken not to overload BRIGHT LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as to be subjected to reverse voltage when turning off the BRIGHT LEDs.

● Storage:

In order to avoid the absorption of moisture, it is recommended to solder BRIGHT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5°C-30°C (41°F) Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
 - a. Completed within 168 hours.
 - b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
 - (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions:
48 hours at 60°C±3°C.

● Package and Label of Products:

- (1) Package: Products are packed in one bag of 3000 pcs (one taping reel) and a label is attached on each bag.
- (2) Label:

